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(12) **United States Design Patent** (10) **Patent No.:** **US D839,272 S**  
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(54) **MEMORY CARD TYPE WIRELESS COMMUNICATION MODULE**

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(51) **LOC (11) Cl.** ..... **14-02**

(52) **U.S. Cl.**  
USPC ..... **D14/435**; D14/436

(58) **Field of Classification Search**  
USPC ..... 2/DIG. 6; 5/417, 419-420, 465, 5/632-634; 108/43; 248/118, 118.1, 248/118.3, 118.5, 205.2, 346, 346.01, 248/346.07, 346.1, 438, 633, 918; 273/338, 438, DIG. 30; 297/218.1, 297/228.12, 352, 377, 440.1, 440.11, 297/440.15, 452.1, 452.16; 312/208.1-208.4, 223.2, 322; 340/710; 345/163, 173; 360/69, 97.02; 361/679.33-679.45, 600, 622, 683, 684, 361/686, 724-728; 400/412, 713-715; 428/137-138, 140, 304.4, 457; 442/9; D3/273; D6/201, 204, 429-431, 449, D6/474, 509-510; D9/432; D10/65, 75, D10/78; D13/103, 119, 162, 184, 199, D13/110; D14/110, 114, 125, 240, 242,

D14/299-302, 314, 348-370, 432-438, D14/496, 478-480.1, 480.3, 480.4, 480.7, D14/483, 484.1, 474, 507, 511, 140, D14/140.1, 167, 168, 203.3, 217, 230, D14/238.1; D18/1, 7, 9, 11; 710/301; 719/328; 379/433.09, 433.11-433.13,  
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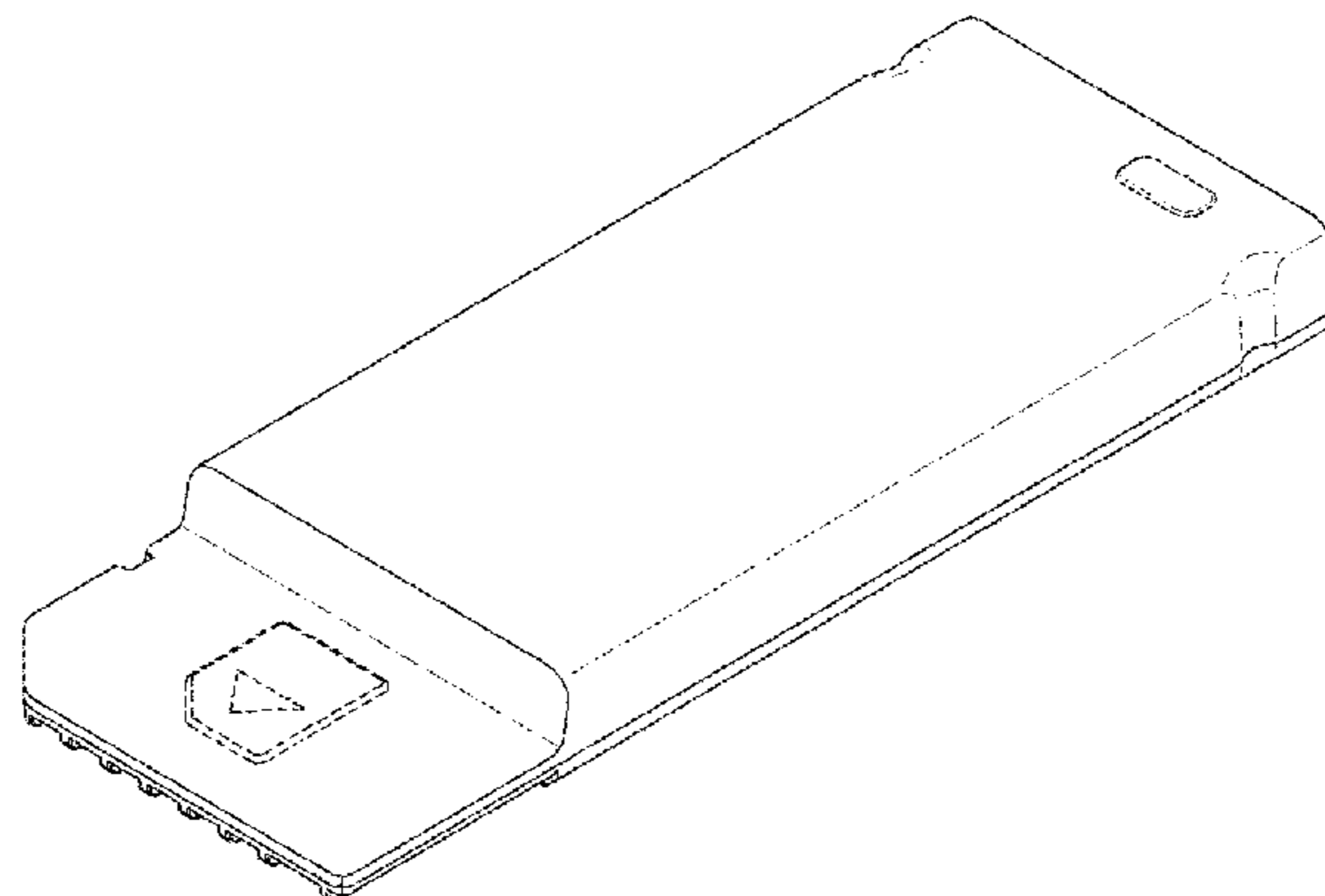
(57) **CLAIM**

We claim the ornamental design for a memory card type wireless communication module, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a memory card type wireless communication module according to our new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; and, FIG. 7 is a bottom plan view thereof. The broken lines depict unclaimed features of the memory card type wireless communication module, shown for purposes of illustration, and form no part of the claimed design.

**1 Claim, 6 Drawing Sheets**



(58) **Field of Classification Search**

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 H05K 5/0295; H05K 5/03; H05K 5/04;  
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 H05K 5/069; H05K 7/00; H05K 7/005;  
 H05K 7/02; H05K 7/023; H05K 7/026;  
 H05K 7/04; H05K 7/10; H05K 7/1418;  
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See application file for complete search history.

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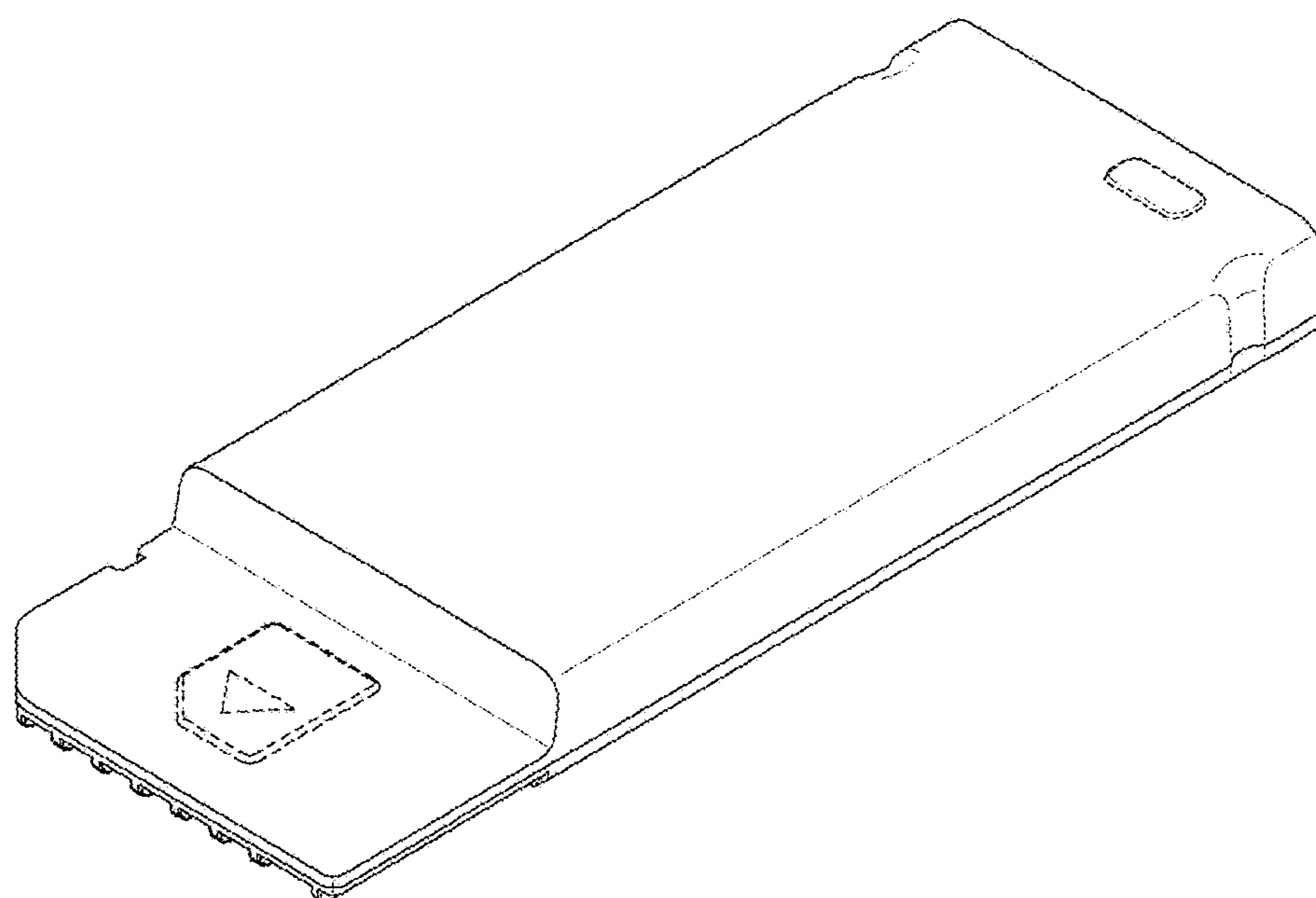


FIG. 1

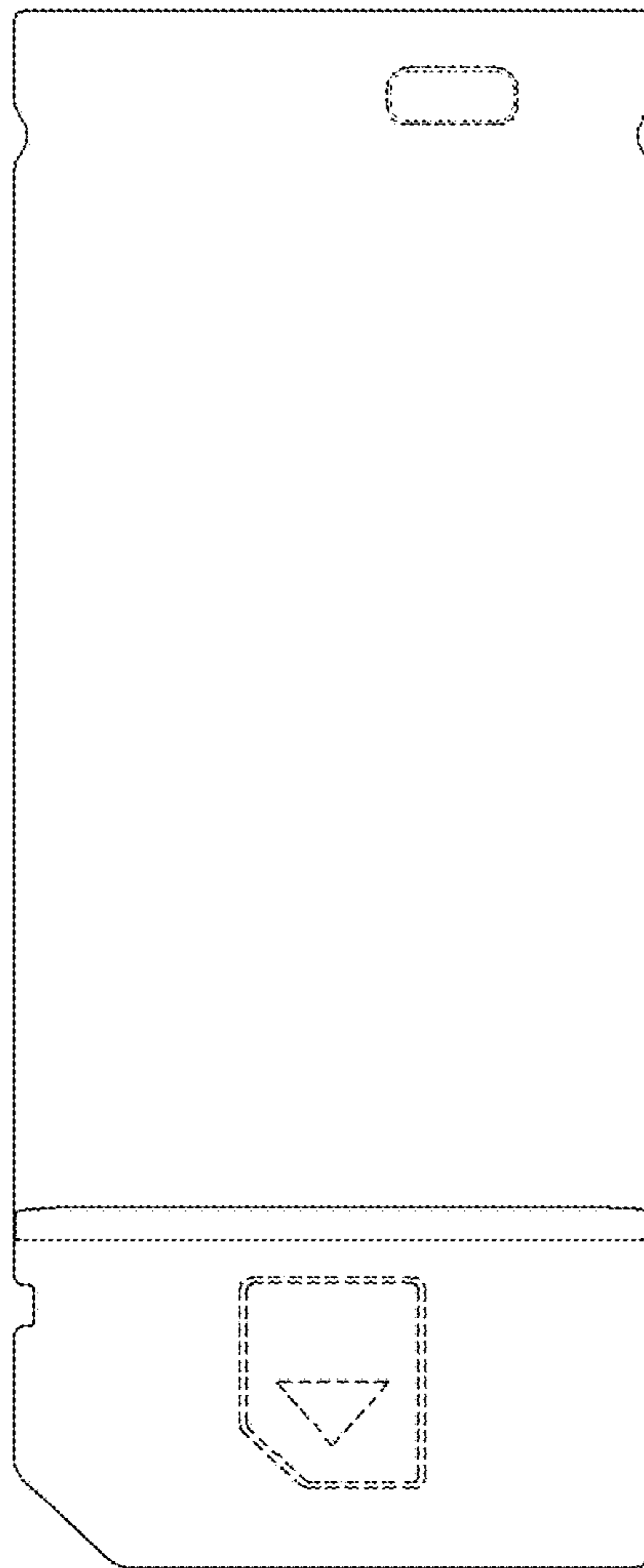
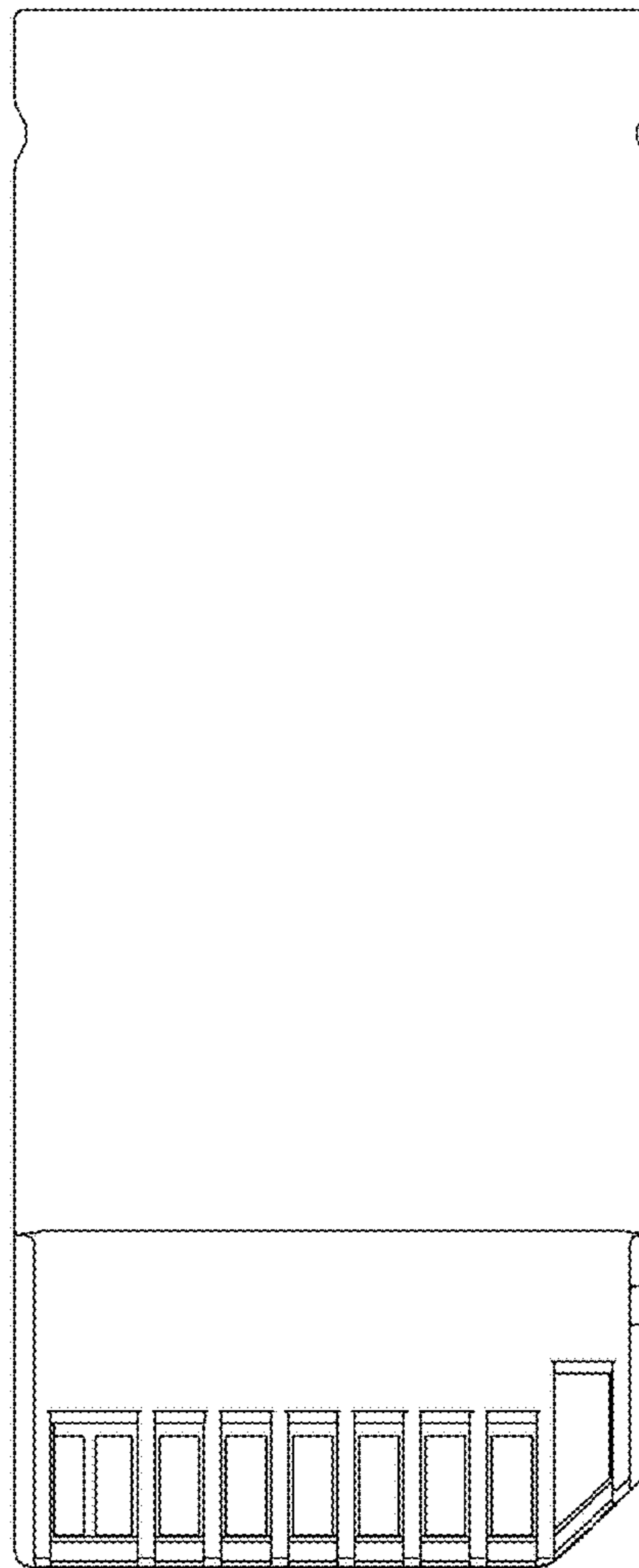


FIG. 2



**FIG. 3**

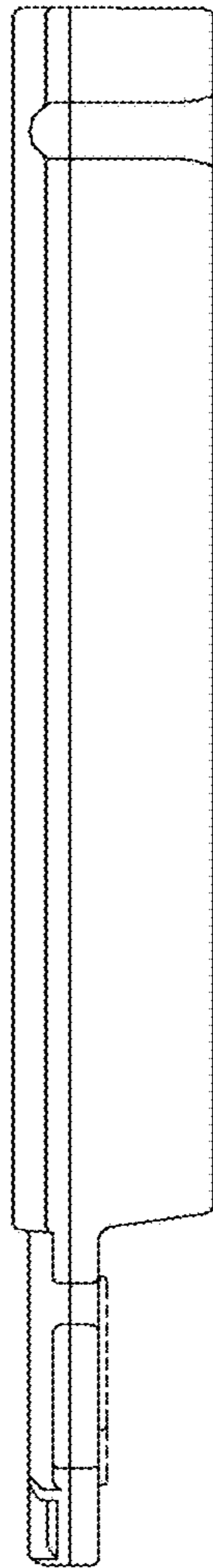
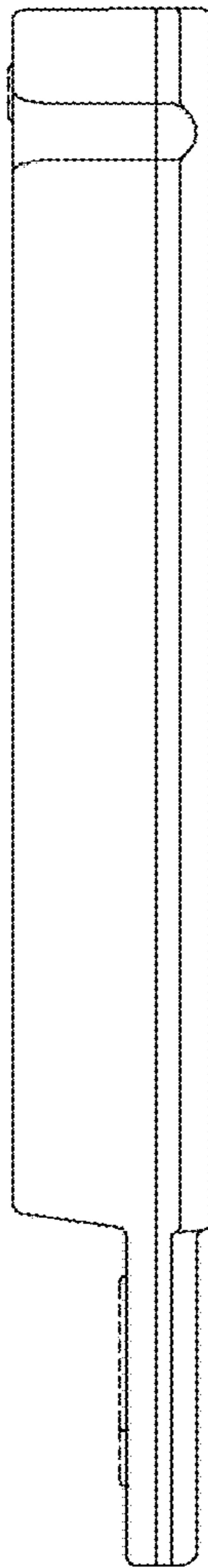
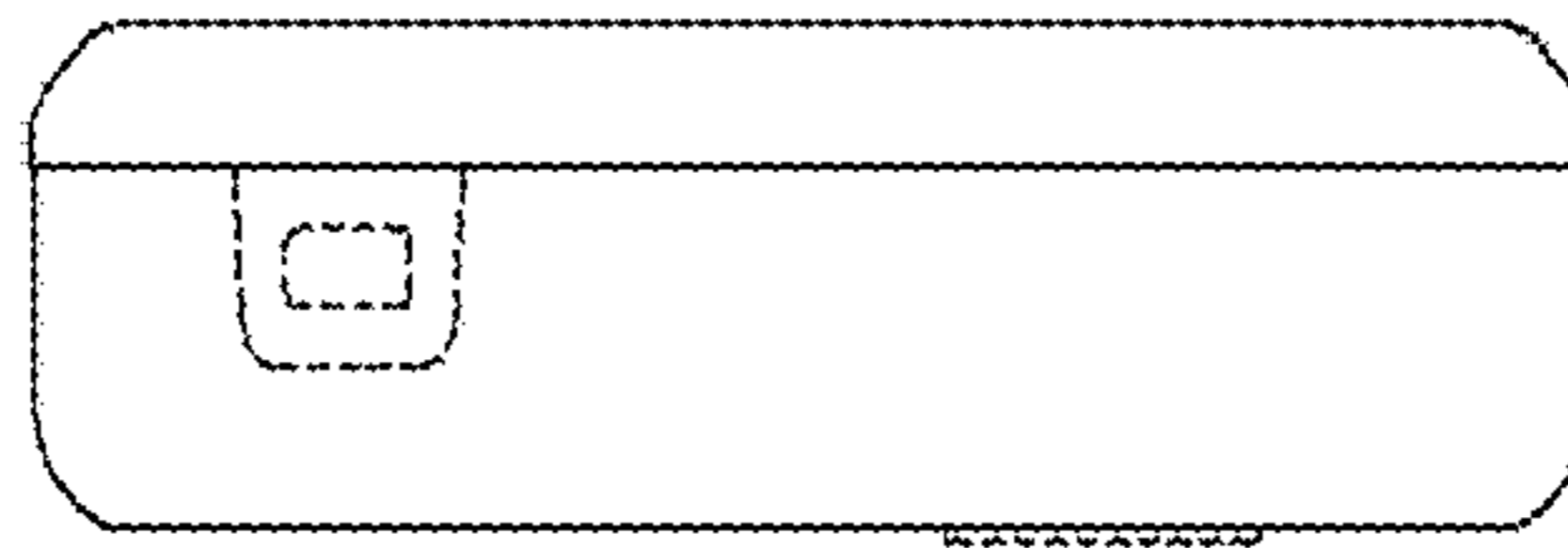


FIG. 4

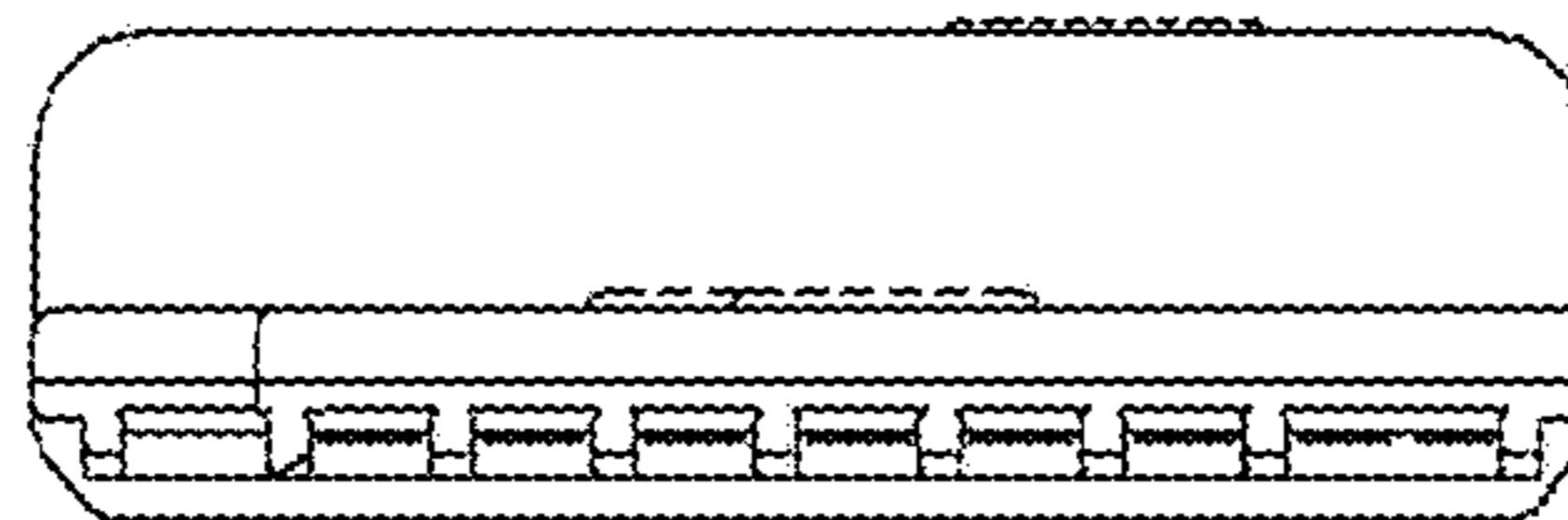




**FIG. 5**



**FIG. 6**



**FIG. 7**